

Description

- 125°C maximum total temperature operation
- 3.1mm x 3.1mm x 1.0mm shielded drum core
- Ferrite core material
- Inductance range from 0.5uH to 220uH
- Current range from 2.27 Amps to 0.106 Amps
- Frequency range up to 1MHz

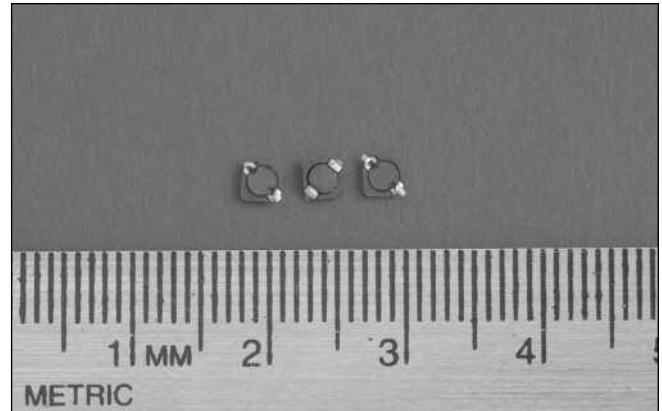


Applications

- Cellular phones, Digital cameras, CD players, PDA's
- Small LCD displays
- LED driver and LED flash circuits
- Hard disk drives
- Backlighting
- EL panel

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (range is application specific)
- Solder reflow temperature: +260°C max. for 10 seconds maximum



Packaging

- Supplied in tape and reel packaging, 4100 per reel

| Part Number | Rated Inductance (µH) | OCL (1) (µH) | Part Marking Designator | I _{rms} (2) Amperes | I _{sat} (3) Amperes | DCR (Ω) typ. @ 20°C | K-factor (4) |
|--------------|-----------------------|--------------|-------------------------|------------------------------|------------------------------|---------------------|--------------|
| SD3110-R50-R | 0.50 | 0.44+/-30% | A | 1.54 | 2.27 | 0.0420 | 216 |
| SD3110-R82-R | 0.82 | 0.82+/-30% | B | 1.30 | 1.67 | 0.0589 | 191 |
| SD3110-1R0-R | 1.0 | 1.05+/-30% | C | 1.21 | 1.47 | 0.0683 | 169 |
| SD3110-1R5-R | 1.5 | 1.60+/-30% | D | 0.99 | 1.19 | 0.103 | 137 |
| SD3110-2R2-R | 2.2 | 2.27+/-30% | E | 0.82 | 1.00 | 0.149 | 115 |
| SD3110-3R3-R | 3.3 | 3.48+/-30% | F | 0.72 | 0.81 | 0.195 | 93 |
| SD3110-4R7-R | 4.7 | 4.96+/-30% | G | 0.59 | 0.68 | 0.285 | 78 |
| SD3110-6R8-R | 6.8 | 6.70+/-30% | H | 0.54 | 0.58 | 0.346 | 67 |
| SD3110-8R2-R | 8.2 | 8.01+/-30% | I | 0.48 | 0.53 | 0.432 | 61 |
| SD3110-100-R | 10.0 | 10.18+/-30% | J | 0.44 | 0.47 | 0.505 | 54 |
| SD3110-150-R | 15.0 | 15.32+/-20% | K | 0.36 | 0.38 | 0.764 | 44 |
| SD3110-220-R | 22.0 | 21.49+/-20% | L | 0.30 | 0.32 | 1.13 | 37 |
| SD3110-330-R | 33.0 | 32.72+/-20% | M | 0.26 | 0.26 | 1.50 | 30 |
| SD3110-470-R | 47.0 | 46.29+/-20% | N | 0.22 | 0.22 | 2.06 | 25 |
| SD3110-680-R | 68.0 | 68.04+/-20% | O | 0.179 | 0.182 | 3.13 | 21 |
| SD3110-820-R | 82.0 | 82.65+/-20% | P | 0.167 | 0.166 | 3.57 | 19 |
| SD3110-101-R | 100 | 101+/-20% | Q | 0.146 | 0.150 | 4.72 | 17 |
| SD3110-151-R | 150 | 149+/-20% | R | 0.127 | 0.123 | 6.16 | 14 |
| SD3110-221-R | 220 | 219+/-20% | S | 0.106 | 0.120 | 9.46 | 12 |

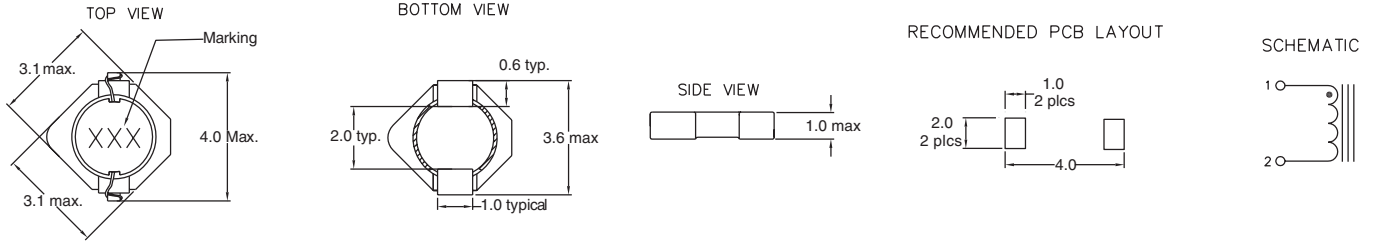
(1) Open Circuit Inductance Test Parameters: 100kHz, 0.1V, 0.0Adc.

(2) I_{rms}: DC current for an approximate DT of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.

(3) I_{sat} Amperes peak for approximately 30% rolloff (@20°C)

(4) K-factor: Used to determine B p-p for core loss (see graph).
 $B_{p-p} = K \cdot L \cdot \Delta I$, B p-p(mT), K: (K factor from table), L: (Inductance in uH),
 ΔI (Peak to peak ripple current in Amps).

Mechanical Diagrams

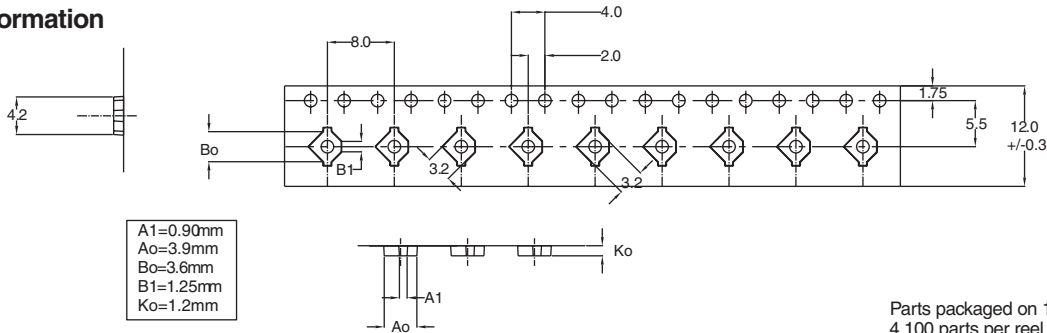


Dimensions are in millimeters.

Part Marking:

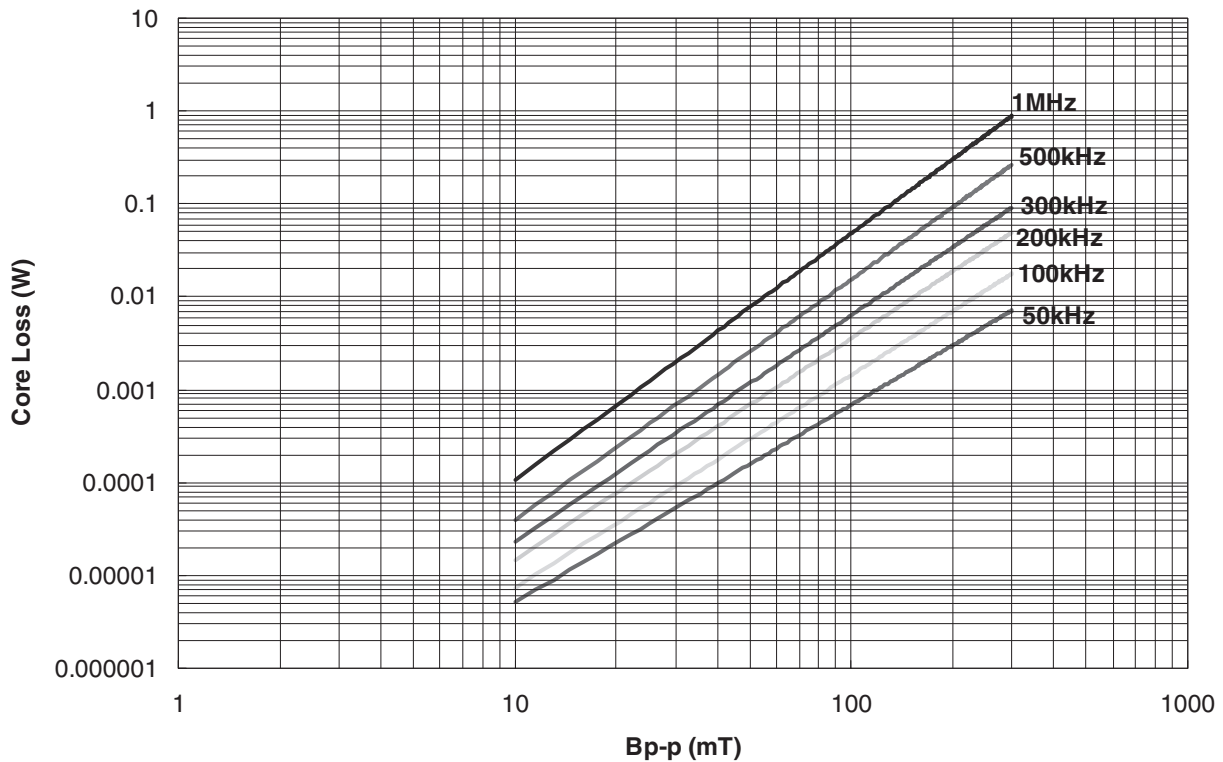
3 Digit Marking: (1st digit: Indicates inductance value per letter in Part Marking Designator); (2nd digit: Bi-weekly production date code); (3rd digit: Last digit of the year produced).

Packaging Information

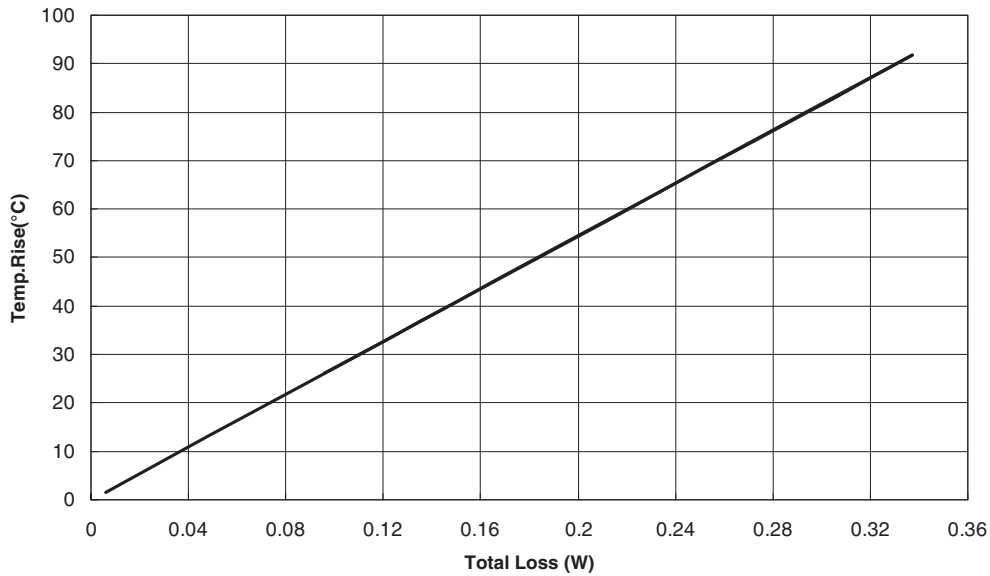


Parts packaged on 13" Diameter reel, 4,100 parts per reel.

Core Loss



Temperature Rise vs. Loss



Inductance Characteristics

OCL Vs Isat

